

P-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY		
V _{DS}	-60	V
R _{DS(on)} V _{GS} = 10 V	62	mΩ
$R_{DS(on)}$ $V_{GS} = 4.5$ V	74	mΩ
I _D	-40	А
Configuration	Sin	gle

FEATURES

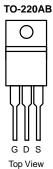
- TrenchFET[®] Power MOSFET
- 100 % UIS Tested

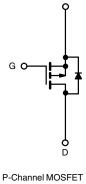
APPLICATIONS

Load Switch

s







ABSOLUTE MAXIMUM RATINGS $T_C = 2$	25 °C, unless othe	rwise noted			
Parameter		Symbol	Limit	Unit	
Gate-Source Voltage		V _{GS}	± 20	V	
Continuous Drain Current (T _J = 175 °C)	T _C = 25 °C	1_	-40		
	T _C = 100 °C	I _D	-30		
Pulsed Drain Current		I _{DM}	- 90	А	
Continuing Source Current (Diode Conduction)		۱ _S	- 30		
Avalanche Current		I _{AS}	- 28	1	
Single Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	7.2	mJ	
Mauimum Davier Diagination	T _C = 25 °C	Р	60 ^a	w	
Maximum Power Dissipation	T _A = 25 °C	P _D	2 ^b	~ ~ ~	
Operating Junction and Storage Temperature Range		T _J , T _{stq}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
handling to Angleing b	t ≤ 10 sec	R _{thJA}	20	25	
Junction-to-Ambient ^D	Steady State		62	75	75 °C/W
Junction-to-Case		R _{thJC}	5	6	

Notes:

a. See SOA curve for voltage derating.

b. Surface Mounted on 1" x 1" FR-4 boad.

Parameter	Symbol	Test Conditions	Min	Typ ^a	Max	Unit	
Static	Symbol	Test conditions	IVIIII	тур	IVIAX	Unit	
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = - 250 μA	- 60				
Gate Threshold Voltage		$V_{DS} = V_{GS}, I_D = -250 \mu A$	- 1.0		- 3.0	V	
•	V _{GS(th)}	$V_{DS} = 0 \text{ V}, V_{CS} = \pm 20 \text{ V}$	- 1.0			~ ^	
Gate-Body Leakage	I _{GSS}	80 00			± 100	nA	
Zava Oata Maltana Duain Ouwant		20 00					
Zero Gate Voltage Drain Current	I _{DSS}					'	
b					- 150		
On-State Drain Current ^b	I _{D(on)}	20 00	- 10			A	
				62			
Drain-Source On-State Resistance ^b	r _{DS(on)}	$\begin{array}{c c c c c c c c c c c c c c c c c c c $					
	D3(01)	V_{GS} = - 10 V, I _D = - 5 A, T _J = 175 °C	- 10 A 62 62 °C 80 mΩ °C 110 mΩ 74 S S 1300 pF 90 13 13 S				
		$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -2 \text{ A}$		74			
Forward Transconductance ^b	9 _{fs}	V _{DS} = - 15 V, I _D = - 5 A		8		S	
Dynamic							
Input Capacitance	C _{iss}			1300			
Output Capacitance	C _{oss}	V_{DS} = - 25 V, V_{GS} = 0 V, f = 1 MHz		120		pF	
Reverse Transfer Capacitance	C _{rss}			90			
Total Gate Charge	Qg			13			
Gate-Source Charge	Q _{gs}	$V_{DS} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -8.4 \text{ A}$		2.3		nC	
Gate-Drain Charge	Q _{gd}			3.2		1	
Gate Resistance	R _g	f = 1 MHz		8.0		Ω	
Turn-On Delay Time ^c	t _{d(on)}			5	10		
Rise Time ^c	t _r	V_{DD} = - 30 V, R _L = 3.57 Ω I _D ≅ - 8.4 A, V _{GEN} = - 10 V, R _G = 2.5 Ω		14	25		
Turn-Off Delay Time ^c	t _{d(off)}			15	25	ns	
Fall Time ^c	t _f			7	12		
Source-Drain Diode Ratings and Cha	racteristics	(T _C = 25 °C) ^b					
Pulsed Current	I _{SM}			- 20		А	
Forward Voltage ^b	V _{SD}	$I_{F} = -2 \text{ A}, V_{GS} = 0 \text{ V}$		- 0.9	- 1.3	V	
Reverse Recovery Time	t _{rr}			50	80	ns	
Reverse Recovery Time	Q _{rr}	I _F = - 8 A, di/dt = 100 A/μs		80	120	nC	

Notes:

a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

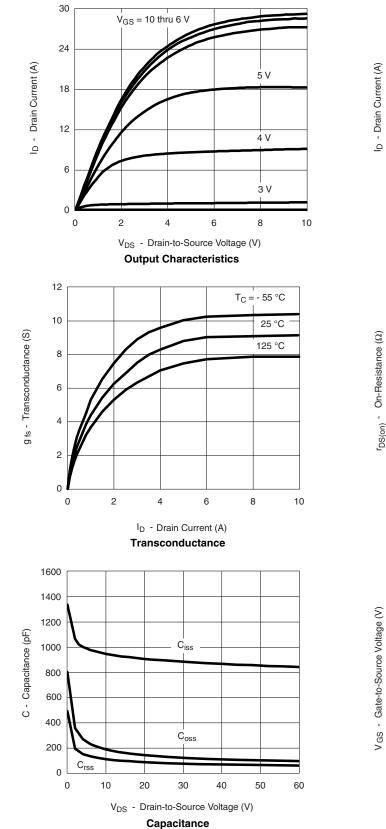
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

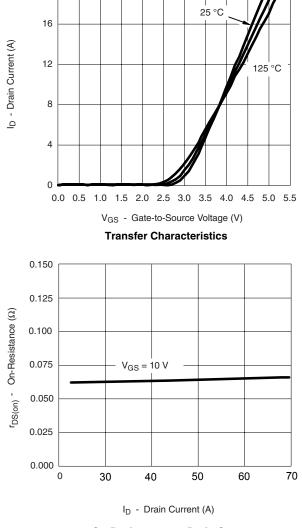
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T_C = - 55 °C

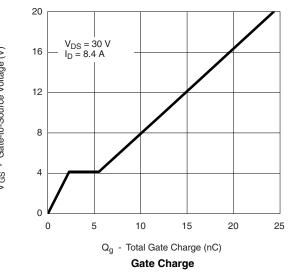


TYPICAL CHARACTERISTICS 25 °C unless noted



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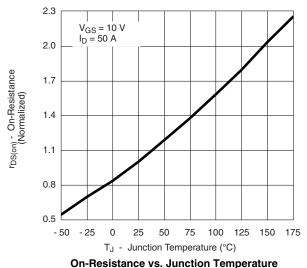
On-Resistance vs. Drain Current

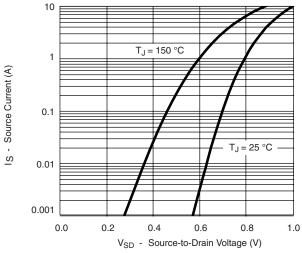


服务热线:400-655-8788

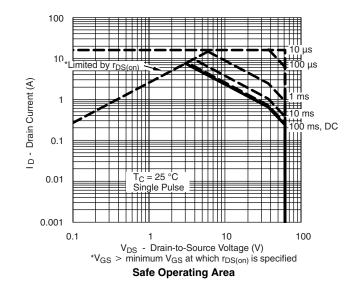


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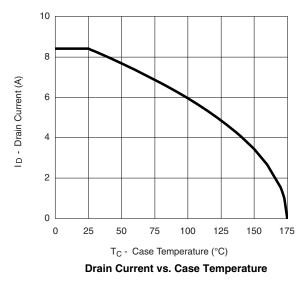




Source-Drain Diode Forward Voltage

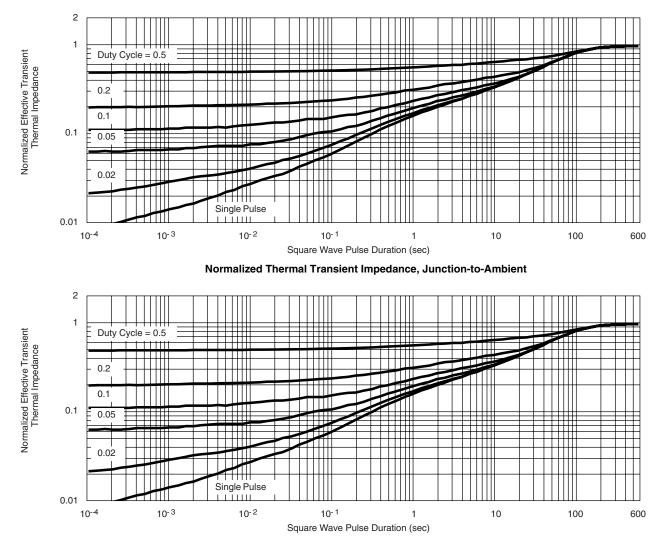


THERMAL RATINGS



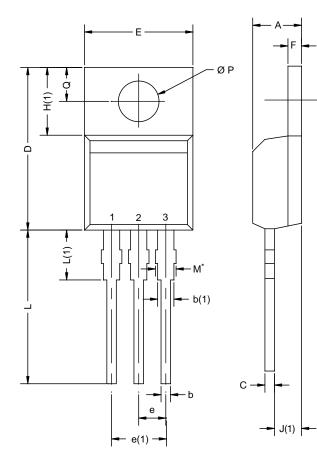


THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Case





TO-220AB

	MILLIM	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
Е	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØΡ	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	

Notes

* M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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